REMARKS

The above amendment is believed to place the claims in proper condition for examination. Early and favorable action is awaited.

Attached hereto is a marked-up version of the changes made to the claims by the current amendment. The attached page is captioned "Version with markings to show changes made."

In the event there are any additional fees required, please charge our Deposit Account No. 01-2340.

Respectfully submitted,

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VERSION WITH MARKINGS TO SHOW CHANGES MADE

Claims 4, 5, 7, 10 and 11 have been amended as follows:

- 4. (Amended) The curable resin composition according to [any of Claims 1 to 3] <u>Claim 1</u> or 2 wherein the main chain of the reactive silicon group-containing polyether oligomer (I) is mainly formed from polypropylene oxide.
- 5. (Amended) The curable resin composition according to [any of Claims 1 to 4] <u>Claim 1</u> or 2

wherein the reactive silicon group-containing polyether oligomer (I) is obtainable by reacting (a) a polyether oligomer the main chain of which comprises a polyether and which contains at least one unsaturated group represented by the general formula (2):

$$H_2C=C(R^3)-R^4-O$$
 (2)

wherein R³ represents a hydrocarbon group containing up to 10 carbon atoms and R⁴ represents a divalent organic group containing 1 to 20 carbon atoms and at least one member selected from the group consisting of hydrogen, oxygen and nitrogen as a constituent atom

(3):

or the general formula

$$HC(R^3) = CH - R^4 - O - \tag{3}$$

wherein R³ and R⁴ are as defined above

per molecule

with a reactive silicon group-containing compound (b)

in the presence of a group VIII transition metal catalyst(c).

7. (Amended) The curable resin composition according to Claim 5 [or 6] wherein R³ in the general formula (2) or (3) represents -CH₃ or -CH₂CH₃.

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10. (Amended) The curable resin composition according to [any of Claims 1 to 9] <u>Claim</u> 1 or 2

wherein the reactive silicon group-containing polyether oligomer (I) has a number average molecular weight of not less than 10,000.

11. (Amended) A direct-glazing method for directly equipping a vehicle with glass using a sealant

wherein the curable resin composition according to [any of Claims 1 to 10] <u>Claim 1 or 2</u> is used as said sealant.